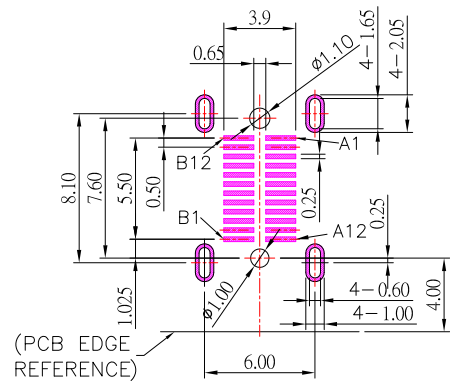




SBC-240P-31x-S175

鍍層厚度:

Blank : 1u"
2 : 15u"
3 : 30u"



P.C.B LAYOUT MOUNTING PATTERN

SPECIFICATIONS

Electrical:

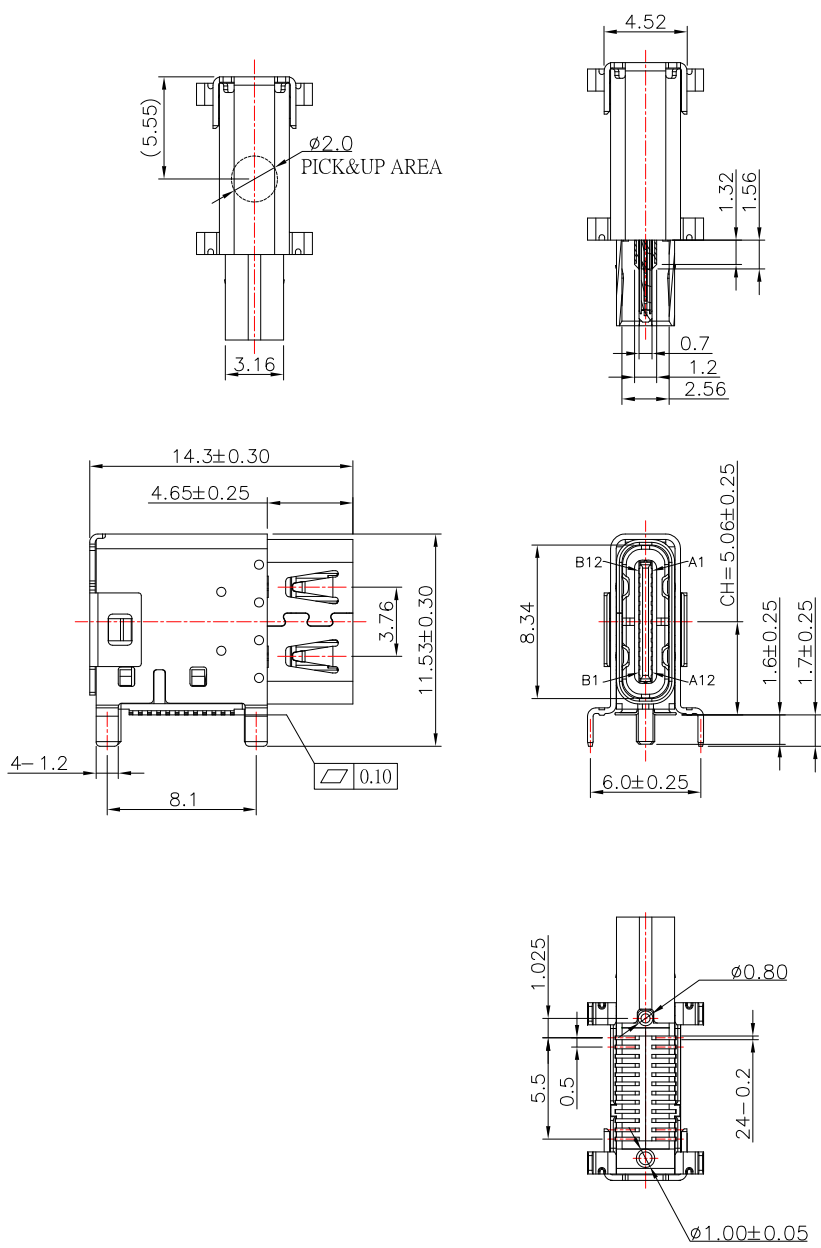
- 1.Rating: 5.0A
- 2.Contact Resistance: 40 mΩ Max
- 3.Insulation Resistance: 100 MΩ Min
- 4.Withstanding Voltage: 100V AC

Material:

- 1.Housing: LCP
- 2.Contact: C18400
- 3.Shell: SUS

Finish:

- 1.Contact: Plated Gold in Mating Area ;
Gold Plated on Solder Balls ;
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer



PIN ASSIGNMENT:

PIN	Signal Name	PIN	Signal Name
A1	GND	B12	GND
A2	SSTXp1	B11	SSRXp1
A3	SSTXn1	B10	SSRXn1
A4	Vbus	B9	Vbus
A5	CC1	B8	SBU2
A6	Dp1	B7	DN2
A7	Dn1	B6	DP2
A8	SBU1	B5	CC2
A9	Vbus	B4	Vbus
A10	SSRXn2	B3	SSTXn2
A11	SSRXp2	B2	SSTXp2
A12	GND	B1	GND



TOLERANCE UNLESS OTHERWISE STATED :	Up to 5 ±0.2 Above 5 ~ 15 ±0.3 Above 15 ~ 30 ±0.4 Above 30 ~ 50 ±0.5 Angle ±0.3°	3RD. ANGEL'S	UNITS	MM
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DRAWN BY:	DATE	MAT'L	TITLE	CONNECTOR
Jack Lu	10/04/23	FINISH	MODLE	USB 3.1 TYPE C 側立式貼片 SMT
CHECKED BY:	DATE	SCALE	DWG NO.	SBC-240P-31x-S175
Jacky Chen	10/04/23	SHEET NO.	PART NO.	SBC-240P-31x-S175
APPROVED BY:	DATE			
Tony Kao	10/04/23			

1	新增尺寸	Jack	100423
ITEM NO.	DESCRIPTION	DRAWN	DATE